

OSRAM LE CG P1AS

Datasheet

Preliminary datasheet version

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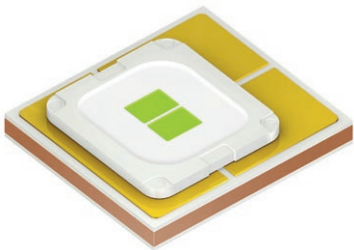
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OSRAM OSTAR® Projection Power

LE CG P1AS

OSRAM OSTAR Projection Power is a high luminance LED for projection applications.



Applications

- Projection & Display

Features

- Package: OSTAR High Power Projection
- Typ. Radiation: 120° (Lambertian emitter)
- Color: Cx = 0.32, Cy = 0.64 acc. to CIE 1931 (● converted green)
- ESD: 2 kV acc. to ANSI/ESDA/JEDEC JS-001 (HBM, Class 2)

Ordering Information

Type	Luminous Flux ¹⁾ I _F = 4000 mA Φ _V	Ordering Code
LE CG P1AS-TPTS-A	2800 ... 3900 lm	Q65113A4267

Maximum Ratings

Parameter	Symbol		Values
Storage Temperature	T_{stg}	min.	-40 °C
		max.	100 °C
Junction Temperature	T_j	max.	150 °C
Forward Current $T_j = T_{j,\text{max}}$	I_F	min.	200 mA
		max.	6700 mA
Forward Current pulsed $D = 0.7$; $f = 240 \text{ Hz}$; $T_j = T_{j,\text{max}}$	$I_{F \text{ pulse}}$		8000 mA
Surge Current $t_p \leq 50 \mu\text{s}$; $D = 0.1$; $T_j = T_{j,\text{max}}$	I_{FS}	max.	9500 mA
ESD withstand voltage acc. to ANSI/ESDA/JEDEC JS-001 (HBM, Class 2)	V_{ESD}		2 kV
Reverse current ²⁾	I_R	max.	200 mA
Max. voltage difference anode-board, cathode-board	$ \Delta V_{a-b} , \Delta V_{c-b} $	max.	40 V

Characteristics

$T_{\text{Board}} = 25\text{ °C}$; $I_F = 4000\text{ mA}$; $f = 1000\text{ Hz}$; $D = 0.50$

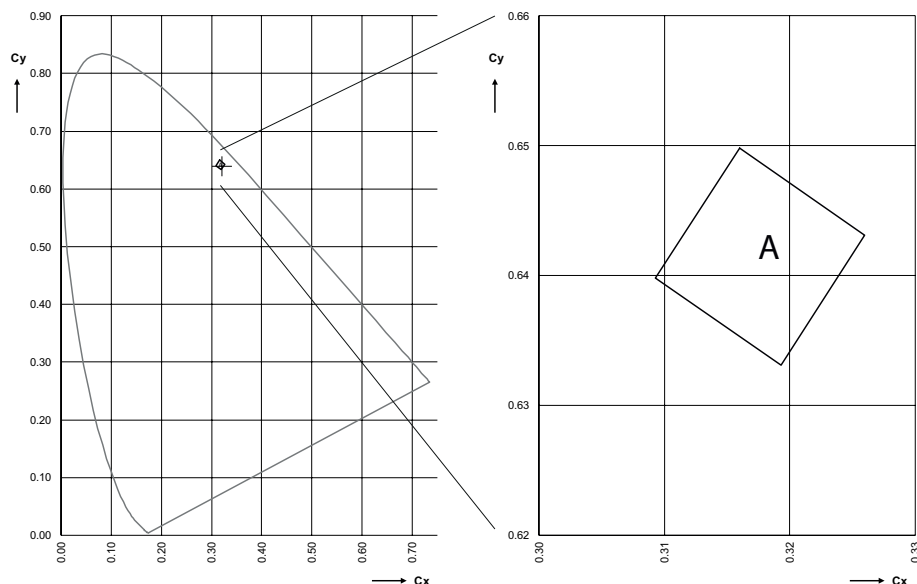
Parameter	Symbol		Values
Chromaticity Coordinate ³⁾ within $\lambda = 500 \dots 600\text{ nm}$	Cx	typ.	0.32
	Cy	typ.	0.64
Peak Wavelength	λ_{peak}	typ.	520 nm
Spectral bandwidth at 50% $I_{\text{rel,max}}$	$\Delta\lambda$	typ.	94 nm
Viewing angle at 50% I_V	2ϕ	typ.	120 °
Radiating surface	A_{color}	typ.	2.00 x 1.35 mm ²
Partial Flux acc. CIE 127:2007 ⁴⁾ $I_F = 4000\text{ mA}$	$\Phi_{\text{E/V, 120°}}$	typ.	0.77
Forward Voltage ⁵⁾ $I_F = 4000\text{ mA}$	V_F	min.	6.4 V
		typ.	6.6 V
		max.	7.6 V
Reverse voltage (ESD device)	$V_{\text{R ESD}}$	min.	45 V
Reverse voltage ²⁾ $I_R = 20\text{ mA}$	V_R	max.	1.2 V
Real thermal resistance junction/solderpoint	$R_{\text{thJS real}}$	typ.	1.30 K / W
Electrical thermal resistance junction/solderpoint with efficiency $\eta_e = 26\text{ %}$	$R_{\text{thJS elec.}}$	typ.	0.96 K / W

Brightness Groups

Group	Luminous Flux ¹⁾ $I_F = 4000 \text{ mA}$ min. Φ_V	Luminous Flux ¹⁾ $I_F = 4000 \text{ mA}$ max. Φ_V
TP	2800 lm	3040 lm
TQ	3040 lm	3300 lm
TR	3300 lm	3590 lm
TS	3590 lm	3900 lm

Chromaticity Coordinate Groups

within $\lambda = 500 \dots 600 \text{ nm}$



Chromaticity Coordinate Groups ³⁾

Group	Cx	Cy
A	0.3093	0.6398
	0.3160	0.6498
	0.3260	0.6431
	0.3193	0.6331

Group Name on Label

Example: TP-A

Brightness

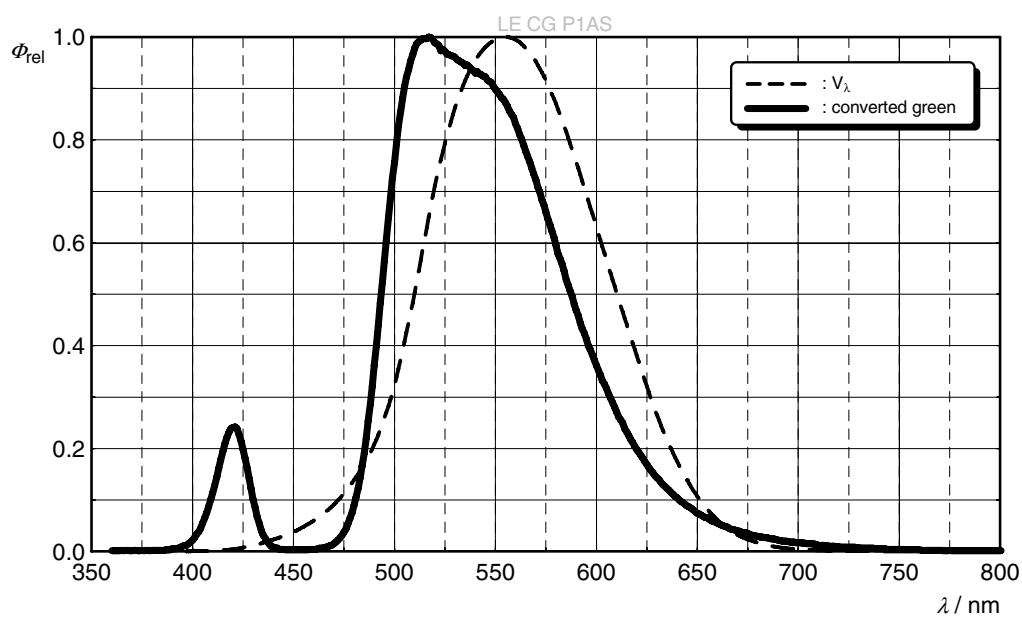
Color Chromaticity

TP

A

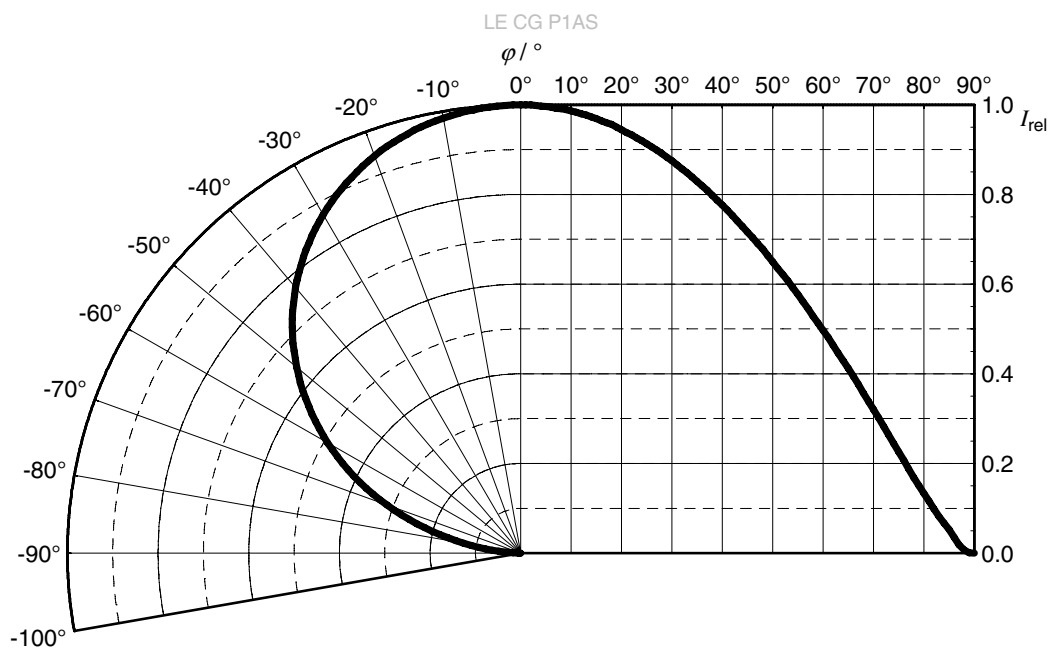
Relative Spectral Emission ⁴⁾

$I_{\text{rel}} = f(\lambda)$; $I_F = 4000 \text{ mA}$; $T_J = 25^\circ\text{C}$



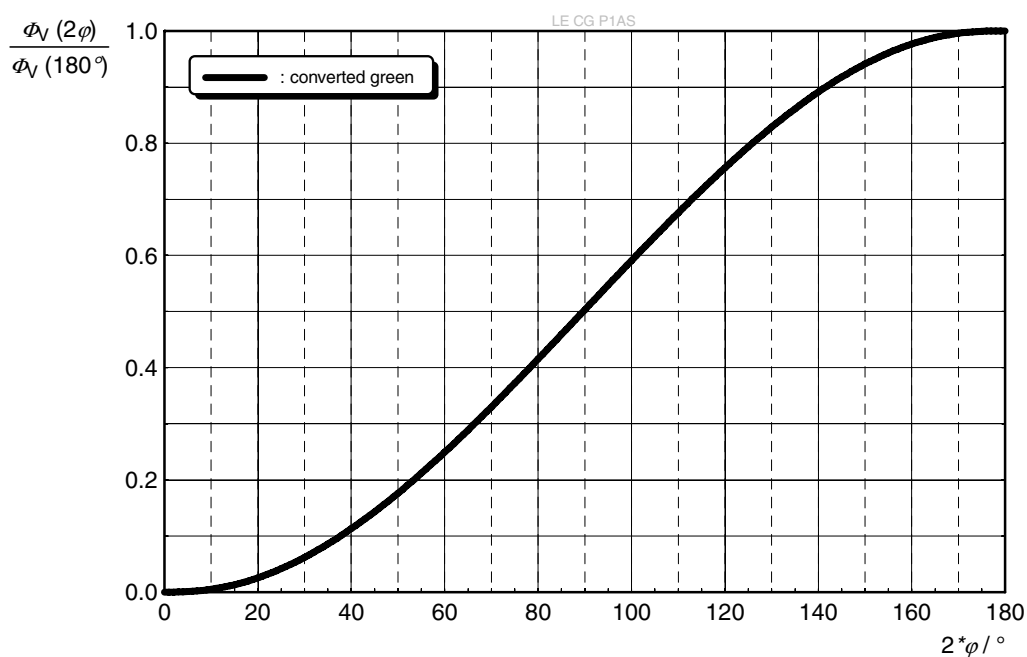
Radiation Characteristics ⁴⁾

$I_{\text{rel}} = f(\phi)$; $T_J = 25^\circ\text{C}$

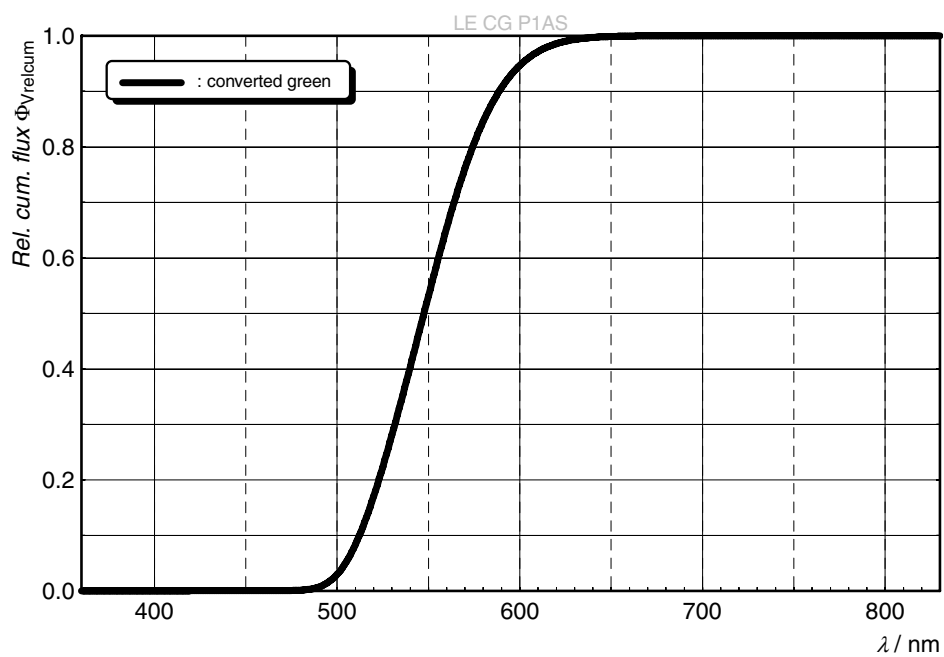


Relative Partial Flux ⁴⁾

$$\Phi_V(2\varphi)/\Phi_V(180^\circ) = f(\varphi); T_J = 25^\circ\text{C}$$

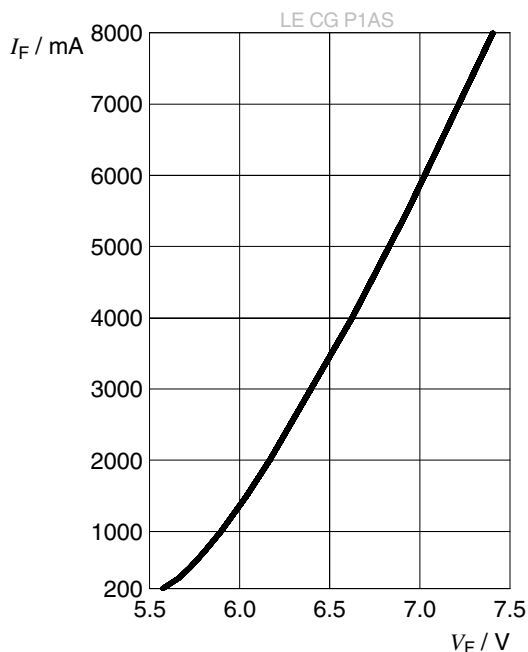
**Relative cumulated Luminous Flux** ⁴⁾

$$\Phi_{V\text{rel-cum}} = f(\lambda); I_F = 4000\text{ mA}; T_J = 25^\circ\text{C}$$

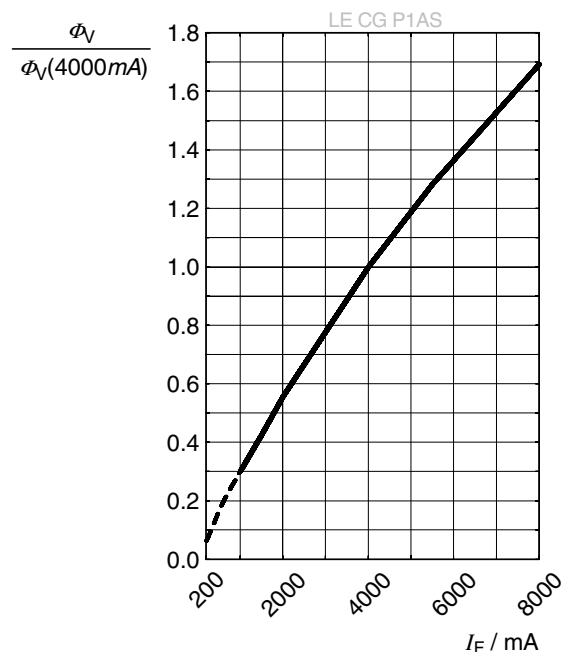


Forward current ⁴⁾

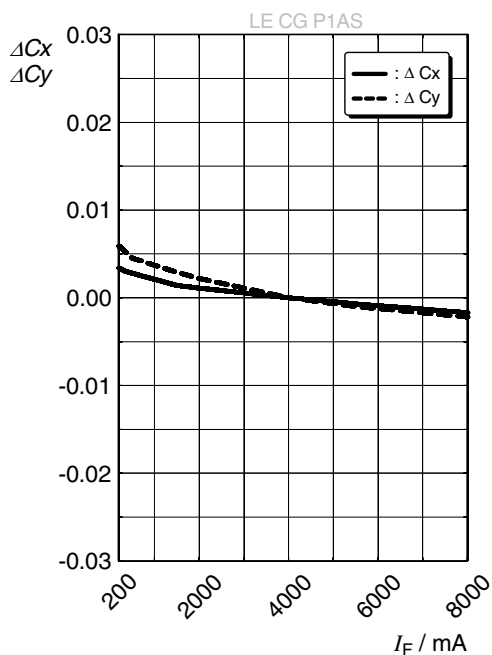
$$I_F = f(V_F); T_J = 25\text{ °C}$$

**Relative Luminous Flux** ^{4), 6)}

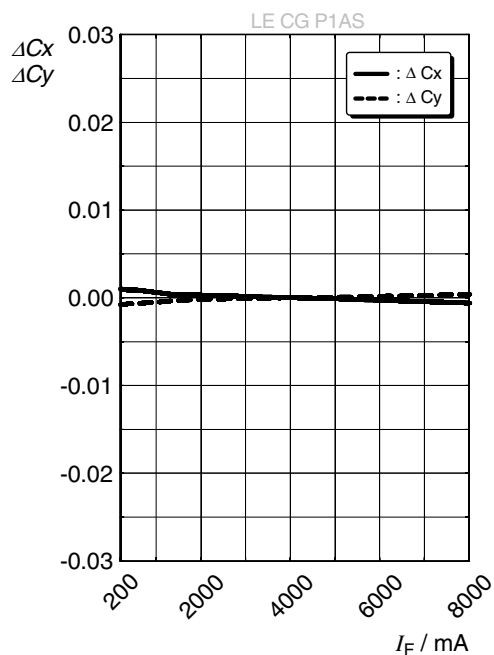
$$\Phi_V / \Phi_V(4000\text{ mA}) = f(I_F); T_J = 25\text{ °C}$$

**Chromaticity Coordinate Shift** ⁴⁾

$$\Delta C_x, \Delta C_y = f(I_F); T_J = 25\text{ °C}; \text{full spectral range}$$

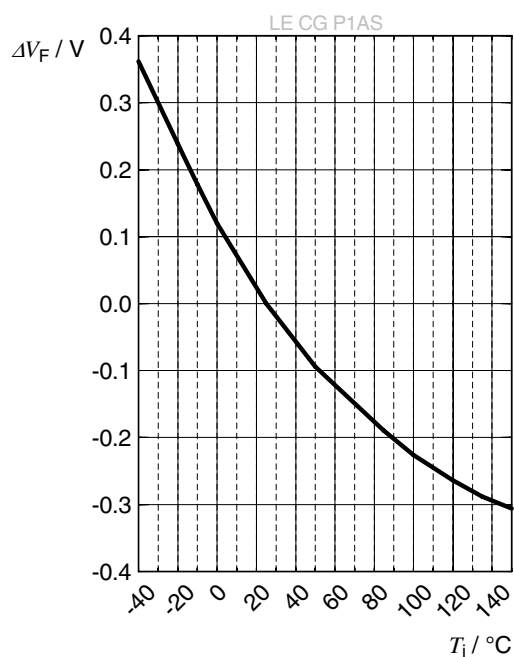
**Chromaticity Coordinate Shift** ⁴⁾

$$\Delta C_x, \Delta C_y = f(I_F); T_J = 25\text{ °C}; \text{within } \lambda = 500 \dots 600\text{ nm}$$

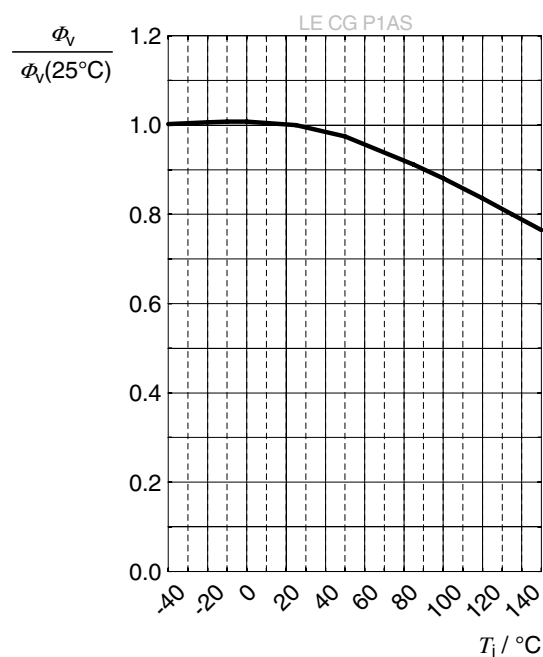


Forward Voltage ⁴⁾

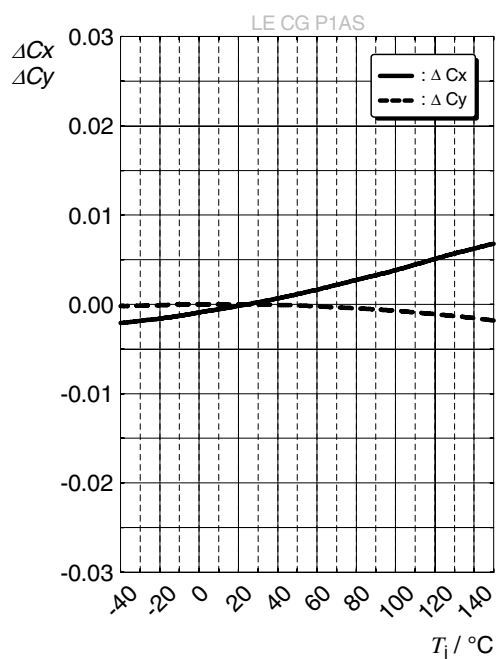
$$\Delta V_F = V_F - V_F(25^\circ\text{C}) = f(T_j); I_F = 4000\text{ mA}$$

**Relative Luminous Flux** ⁴⁾

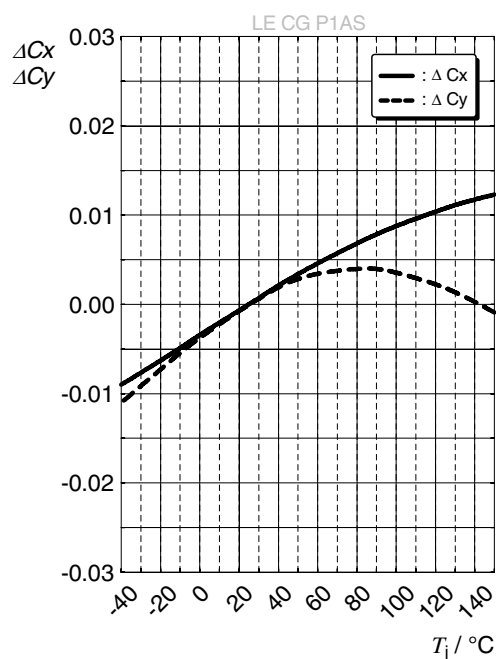
$$\Phi_V / \Phi_V(25^\circ\text{C}) = f(T_j); I_F = 4000\text{ mA}$$

**Chromaticity Coordinate Shift** ⁴⁾

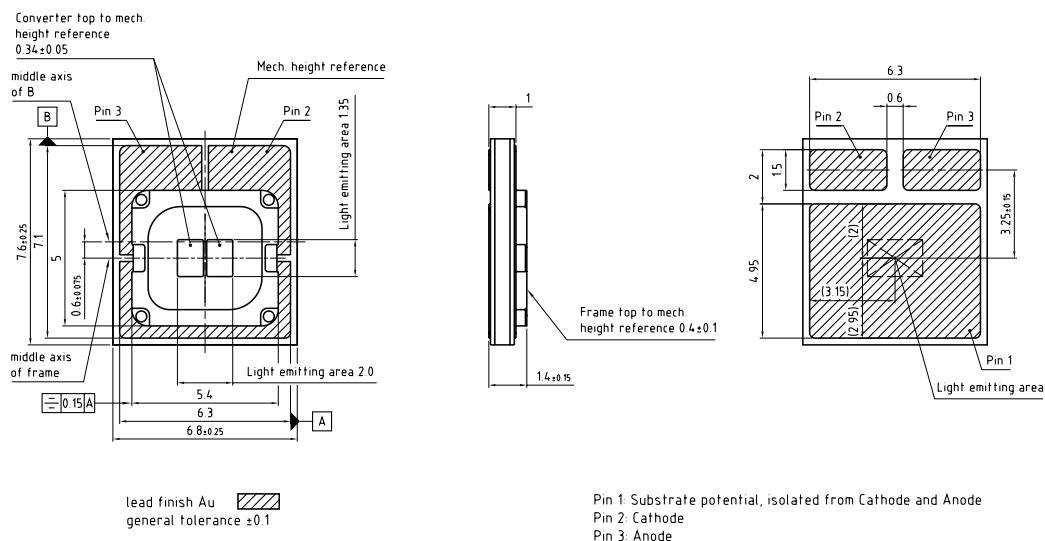
$$\Delta C_x, \Delta C_y = f(T_j); I_F = 4000\text{ mA}; \text{within } \lambda = 500 \dots 600\text{ nm}$$

**Chromaticity Coordinate Shift** ⁴⁾

$$\Delta C_x, \Delta C_y = f(T_j); I_F = 4000\text{ mA}; \text{full spectral range}$$



Dimensional Drawing ⁷⁾



C63062-A4436-A4-03

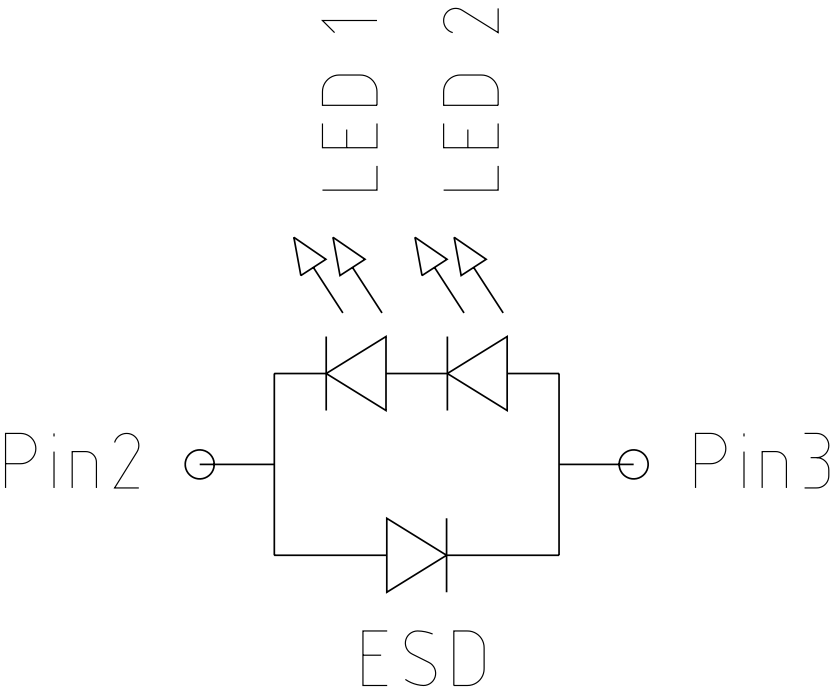
Further Information:

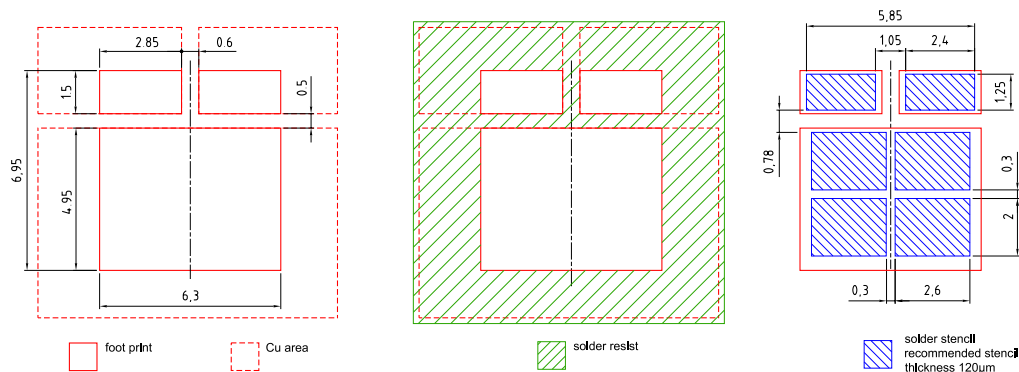
Approximate Weight: 380.0 mg

ESD advice: The device is protected by ESD device which is connected in parallel to the Chip.

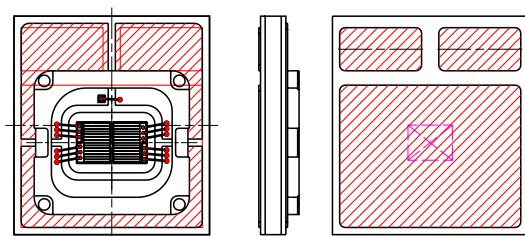
Notes: Package not suitable for any kind of wet cleaning or ultrasonic cleaning.

Electrical Internal Circuit



Recommended Solder Pad ⁷⁾

Component Location on Pad

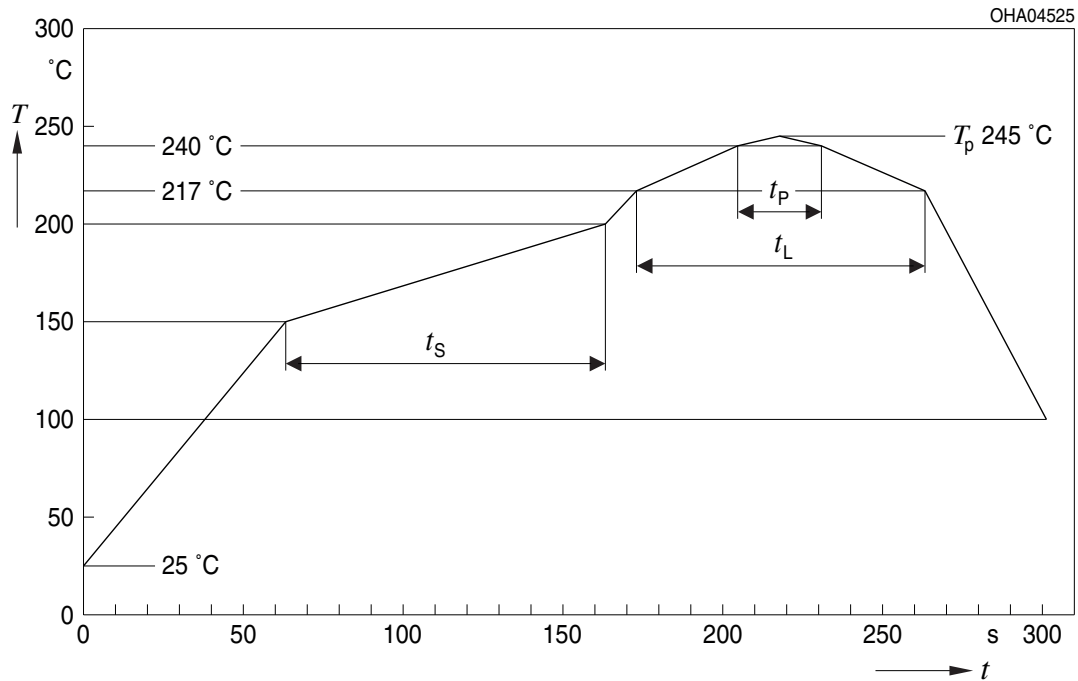


E062.3010.313-01

For superior solder joint connectivity results we recommend soldering under standard nitrogen atmosphere. To ensure a high solder joint reliability and to minimize the risk of solder joint cracks, the customer is responsible to evaluate the combination of PCB board and solder paste material for his application.

Reflow Soldering Profile

Product complies to MSL Level 2 acc. to JEDEC J-STD-020E

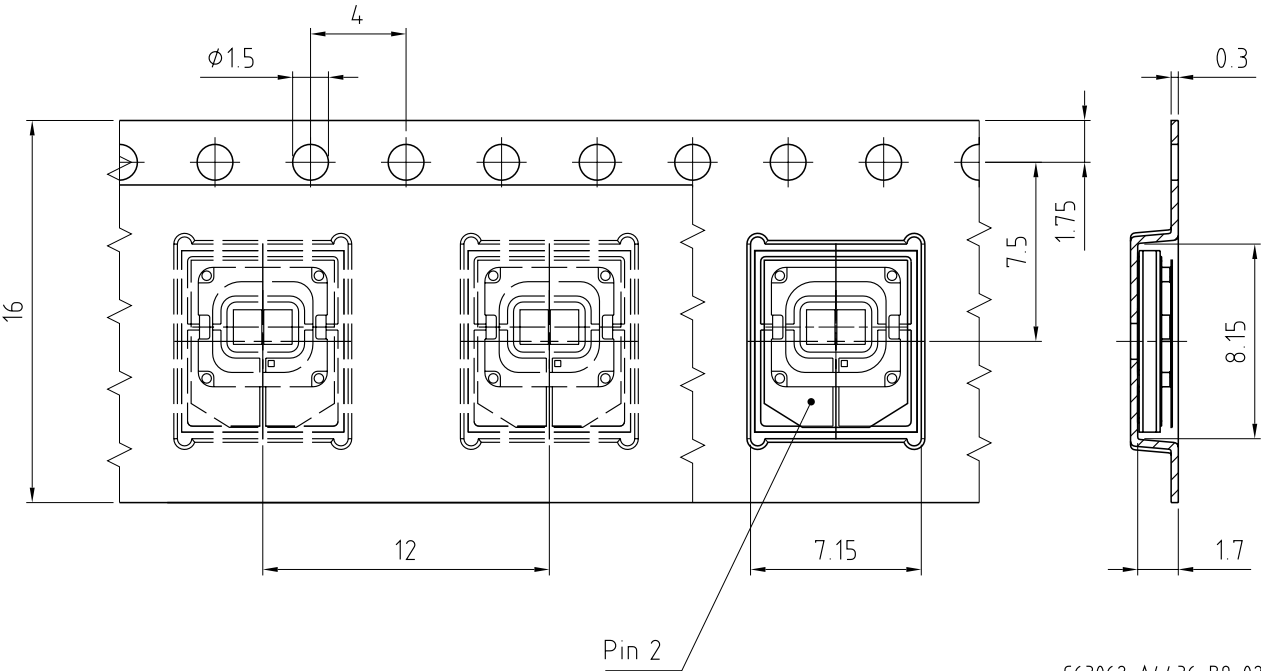


Profile Feature	Symbol	Pb-Free (SnAgCu) Assembly			Unit
		Minimum	Recommendation	Maximum	
Ramp-up rate to preheat*) 25°C to 150°C			2	3	K/s
Time t_s T_{Smin} to T_{Smax}	t_s	60	100	120	s
Ramp-up rate to peak*) T_{Smax} to T_p			2	3	K/s
Liquidus temperature	T_L		217		$^{\circ}\text{C}$
Time above liquidus temperature	t_L		80	100	s
Peak temperature	T_p		245	260	$^{\circ}\text{C}$
Time within 5°C of the specified peak temperature $T_p - 5\text{ K}$	t_p	10	20	30	s
Ramp-down rate*) T_p to 100°C			3	6	K/s
Time 25°C to T_p				480	s

All temperatures refer to the center of the package, measured on the top of the component

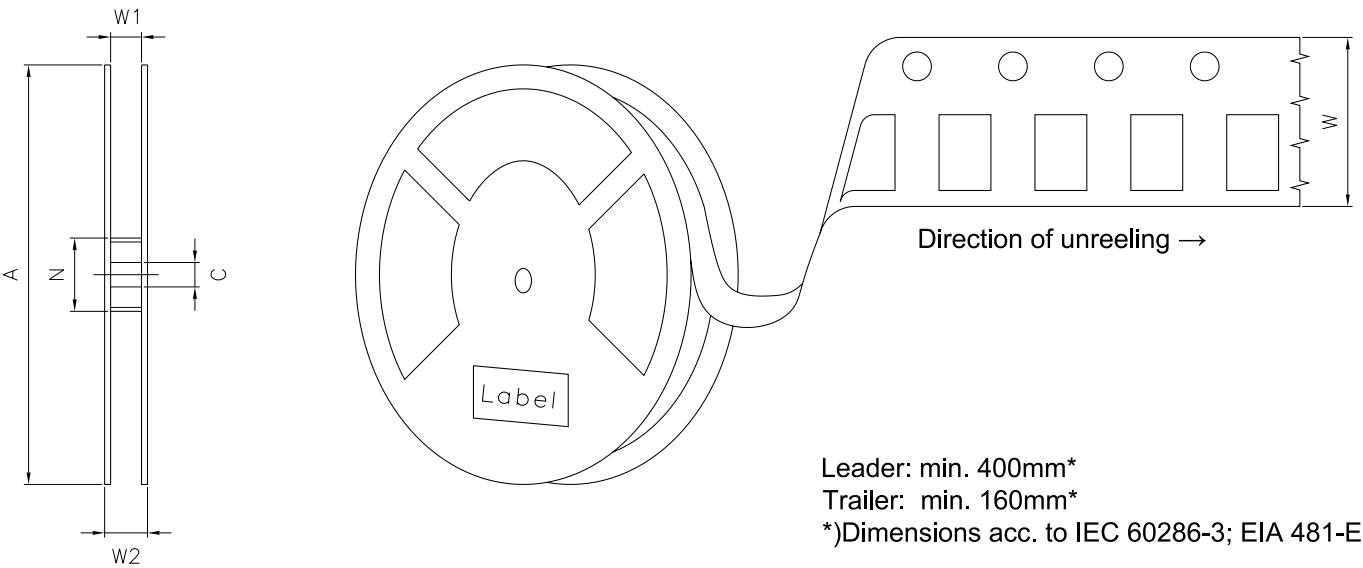
*) slope calculation DT/Dt : Dt max. 5 s; fulfillment for the whole T-range

Taping ⁷⁾



C63062-A4436-B9-02

Tape and Reel ⁸⁾



Reel Dimensions

A	W	N _{min}	W ₁	W _{2 max}	Pieces per PU
180 mm	16 + 0.3 / - 0.1 mm	60/100 mm	16.4 + 2 mm	22.4 mm	500

Barcode-Product-Label (BPL)

OSRAM Opto
Semiconductors

LX XXXX

BIN1: XX-XX-X-XXX-X

(6P) BATCH NO: 1234567890

(1T) LOT NO: 1234567890

(X) PROD NO: 123456789

RoHS Compliant

(9D) D/C: 1234

(Q) QTY: 9999

ML Temp ST
X XXX °C X

Pack: RXX
DEMY XXX
X_X123_1234.1234 X

OHA04563

Notes

The evaluation of eye safety occurs according to the standard IEC 62471:2006 (photo biological safety of lamps and lamp systems). Within the risk grouping system of this IEC standard, the device specified in this data sheet fall into the class **moderate risk (exposure time 0.25 s)**. Under real circumstances (for exposure time, conditions of the eye pupils, observation distance), it is assumed that no endangerment to the eye exists from these devices. As a matter of principle, however, it should be mentioned that intense light sources have a high secondary exposure potential due to their blinding effect. When looking at bright light sources (e.g. headlights), temporary reduction in visual acuity and afterimages can occur, leading to irritation, annoyance, visual impairment, and even accidents, depending on the situation.

Subcomponents of this device contain, in addition to other substances, metal filled materials including silver. Metal filled materials can be affected by environments that contain traces of aggressive substances. Therefore, we recommend that customers minimize device exposure to aggressive substances during storage, production, and use. Devices that showed visible discoloration when tested using the described tests above did show no performance deviations within failure limits during the stated test duration. Respective failure limits are described in the IEC60810.

For further application related information please visit www.osram-os.com/appnotes

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For information on the types in question please contact our Sales Organization.

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Packing

Please use the recycling operators known to you. We can also help you – get in touch with your nearest sales office. By agreement we will take packing material back, if it is sorted. You must bear the costs of transport. For packing material that is returned to us unsorted or which we are not obliged to accept, we shall have to invoice you for any costs incurred.

Product and functional safety devices/applications or medical devices/applications

Our components are not developed, constructed or tested for the application as safety relevant component or for the application in medical devices.

Our products are not qualified at module and system level for such application.

In case buyer – or customer supplied by buyer – considers using our components in product safety devices/applications or medical devices/applications, buyer and/or customer has to inform our local sales partner immediately and we and buyer and /or customer will analyze and coordinate the customer-specific request between us and buyer and/or customer.

Glossary

- 1) **Brightness:** Brightness values are measured during a pulse train of 100 ms with a pulse width of 500 μ s and a frequency of 1 kHz, with an internal reproducibility of $\pm 8\%$ and an expanded uncertainty of $\pm 11\%$ (acc. to GUM with a coverage factor of $k = 3$). The peak brightness is calculated according to the pulse duration and frequency.
- 2) **Reverse Operation:** This product is intended to be operated applying a forward current within the specified range. Applying any continuous reverse bias or forward bias below the voltage range of light emission shall be avoided because it may cause migration which can change the electro-optical characteristics or damage the LED.
- 3) **Chromaticity coordinate groups:** Chromaticity coordinates are measured during a pulse train of 100 ms with a pulse width of 500 μ s and a frequency of 1 kHz, with an internal reproducibility of $\pm 0,005$ and an expanded uncertainty of $\pm 0,01$ (acc. to GUM with a coverage factor of $k = 3$).
- 4) **Typical Values:** Due to the special conditions of the manufacturing processes of semiconductor devices, the typical data or calculated correlations of technical parameters can only reflect statistical figures. These do not necessarily correspond to the actual parameters of each single product, which could differ from the typical data and calculated correlations or the typical characteristic line. If requested, e.g. because of technical improvements, these typ. data will be changed without any further notice.
- 5) **Forward Voltage:** The forward voltage is measured during a pulse of typical 500 μ s, with an internal reproducibility of $\pm 0,05$ V and an expanded uncertainty of $\pm 0,1$ V (acc. to GUM with a coverage factor of $k=3$).
- 6) **Characteristic curve:** In the range where the line of the graph is broken, you must expect higher differences between single devices within one packing unit.
- 7) **Tolerance of Measure:** Unless otherwise noted in drawing, tolerances are specified with ± 0.1 and dimensions are specified in mm.
- 8) **Tape and Reel:** All dimensions and tolerances are specified acc. IEC 60286-3 and specified in mm.

Revision History

Version	Date	Change
0.0	2022-09-19	Initial Version New Layout Applications
0.1	2022-09-26	Characteristics

Preliminary datasheet version



EU RoHS and China RoHS compliant product

此产品符合欧盟 RoHS 指令的要求；
按照中国的相关法规和标准，
不含有毒有害物质或元素。

Published by ams-OSRAM AG

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